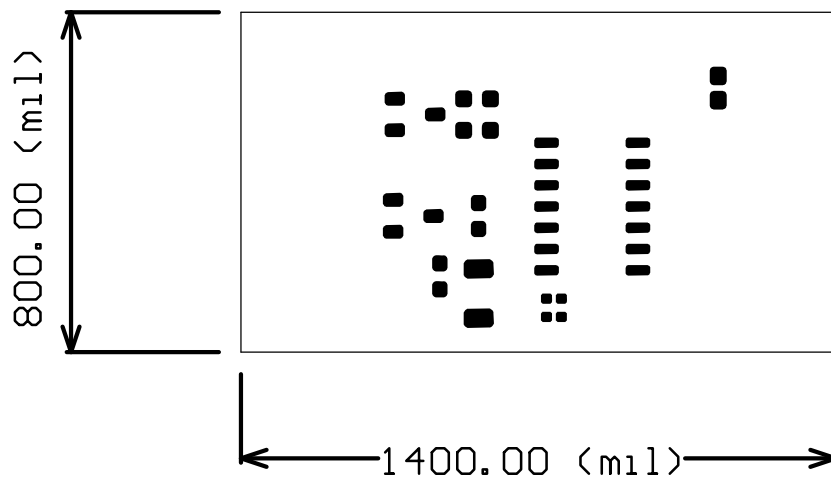
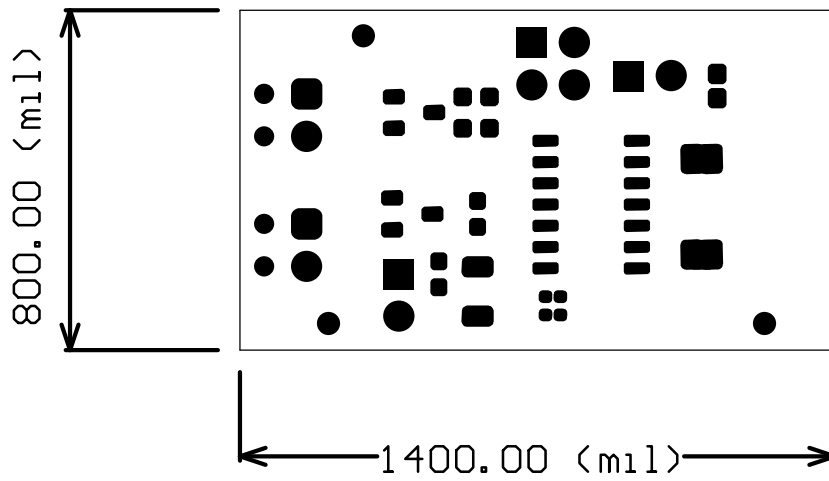


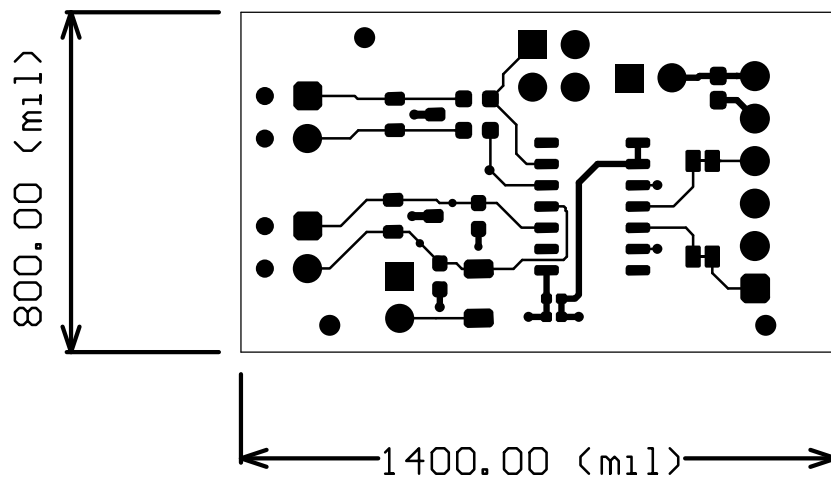
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Date: 10/22/2024
Layer Name: Top Overlay
Company: RENESAS



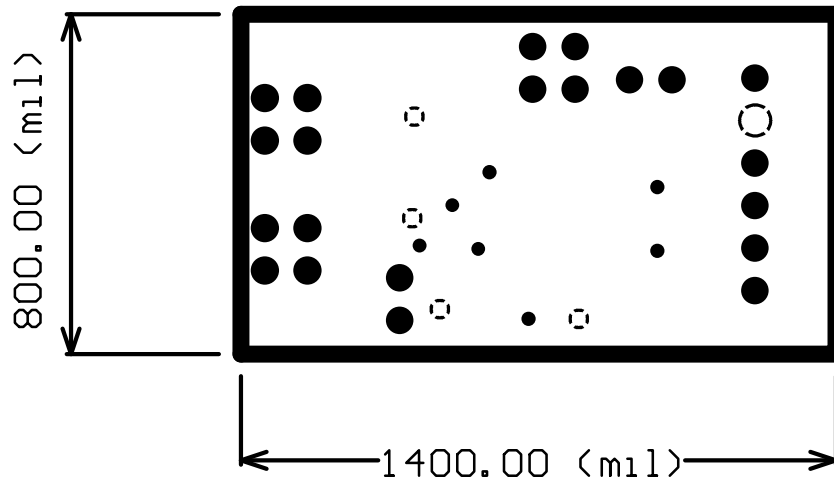
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Date: 10/22/2024
Layer Name: Top Paste
Company: RENESAS



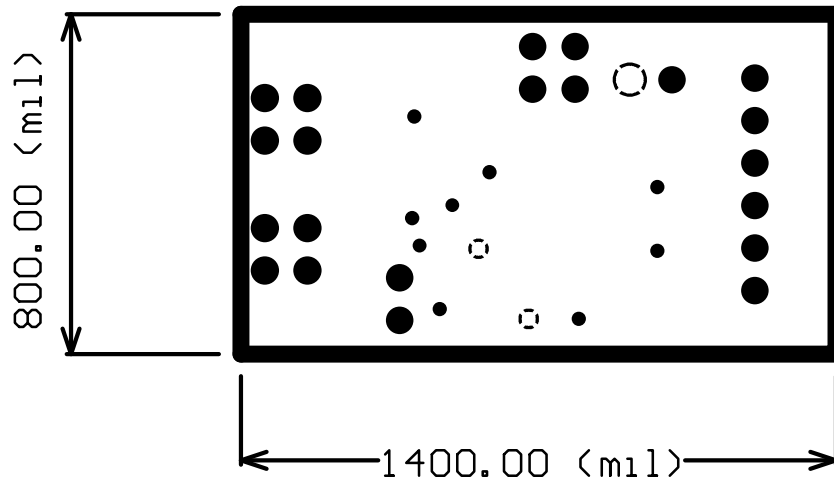
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Date: 10/22/2024
Layer Name: Top Solder Mask
Company: RENESAS



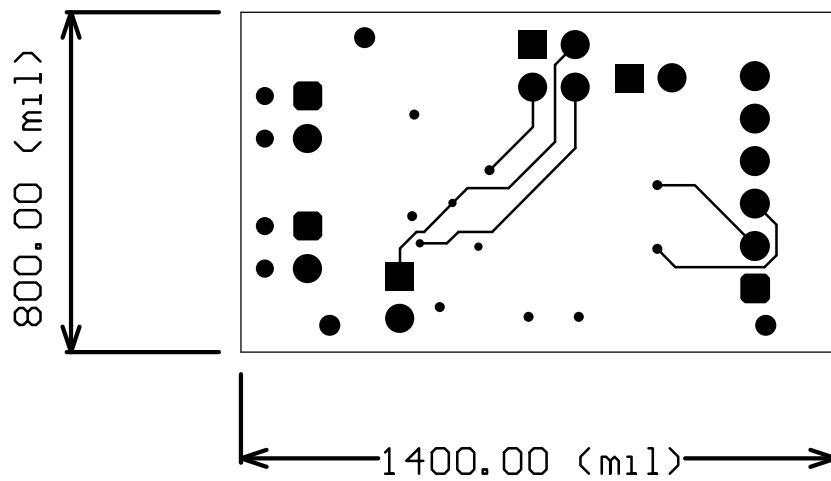
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Date: 10/22/2024
Layer Name: Top Layer
Company: RENESAS



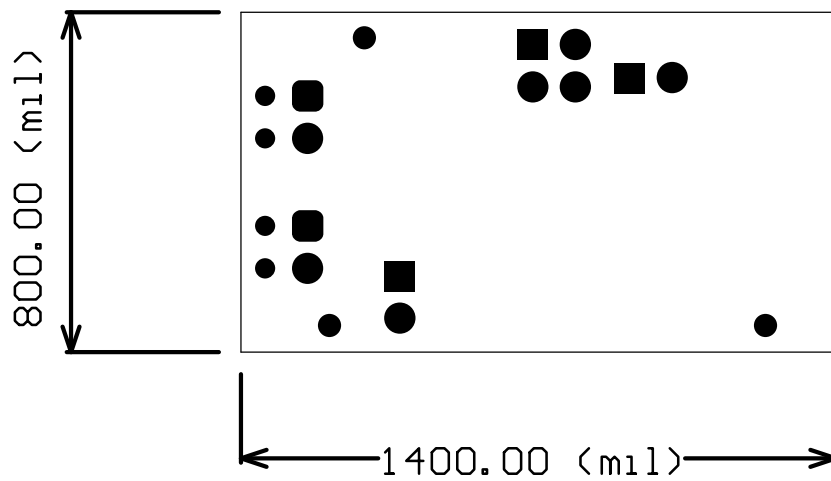
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Date: 10/22/2024
Layer Name: Layer 1
Company: RENESAS



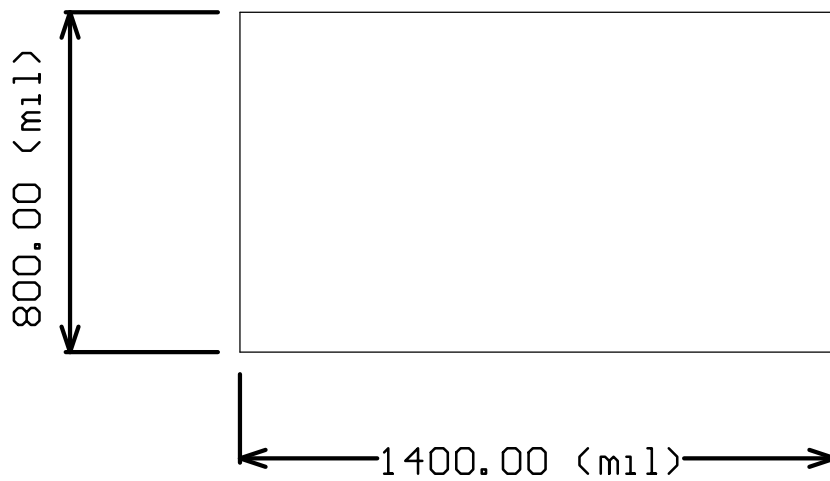
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Date: 10/22/2024
Layer Name: Layer 2
Company: RENESAS



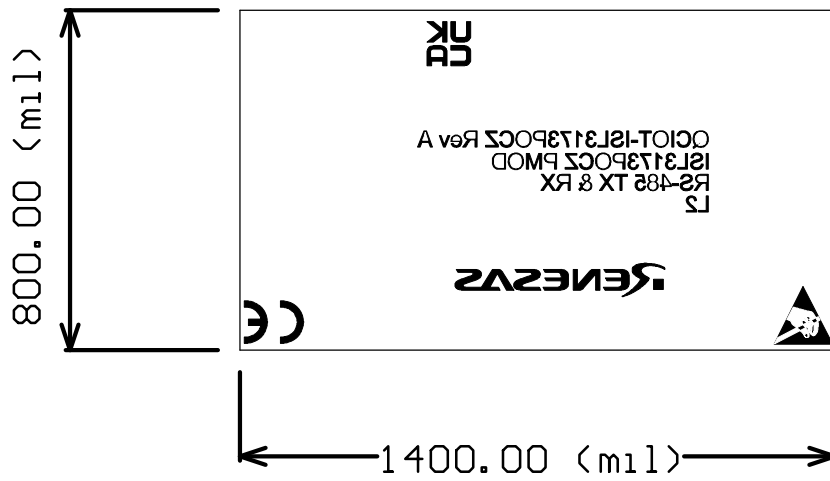
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Date: 10/22/2024
Layer Name: Bottom Layer
Company: RENESAS



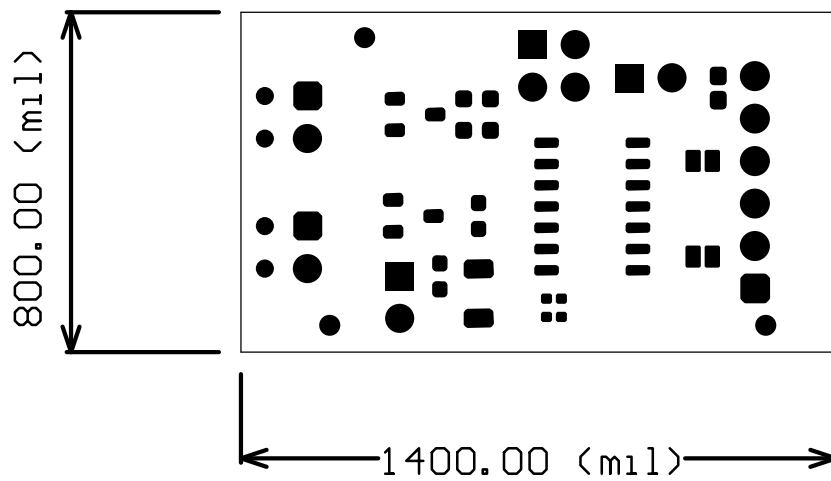
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Date: 10/22/2024
Layer Name: Bottom Solder Mask
Company: RENESAS



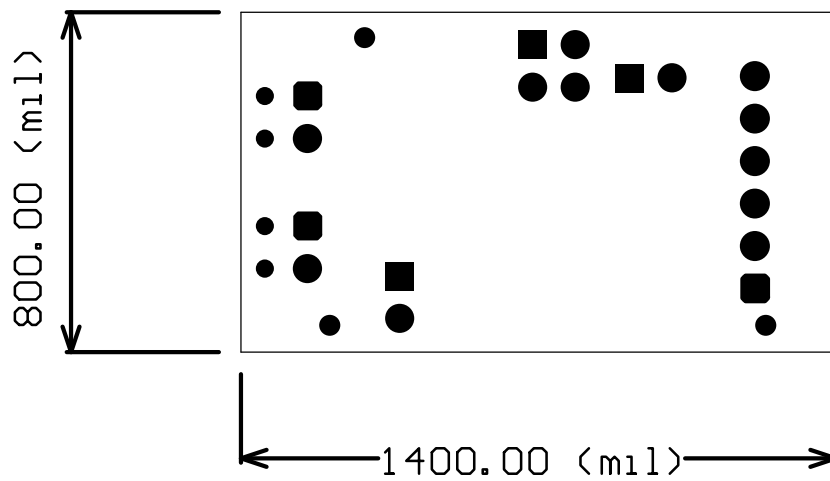
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Date: 10/22/2024
Layer Name: Bottom Paste
Company: RENESAS



Filename: QCIOT-ISL3173POCZ Rev A.PcbDoc
Date: 10/22/2024
Layer Name: Bottom Overlay
Company: RENESAS

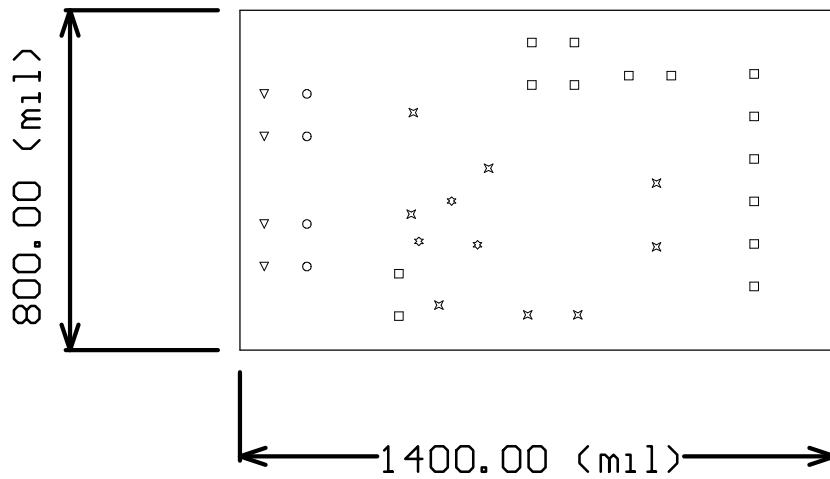


Filename: QCIOT-ISL3173POCZ Rev A.PcbDoc
Date: 10/22/2024
Layer Name: Top Pad Master
Company: RENESAS



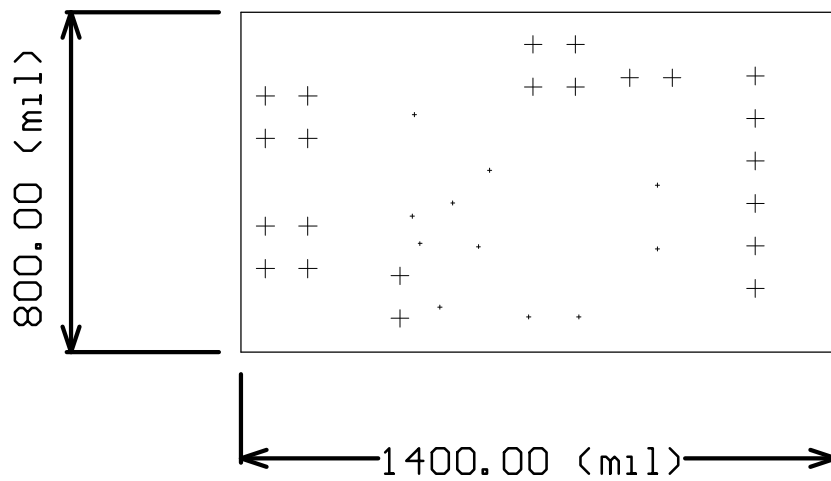
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Date: 10/22/2024
Layer Name: Bottom Pad Master
Company: RENESAS

	33 Total			
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Filename: QCIOT-ISL3173POCZ Rev A.PcbDoc
Date: 10/22/2024
Layer Name: Drill Drawing (Top Layer, Bottom Layer)
Company: RENESAS

Layer	Name
	Top C
	Top S
	Top S
1	Top L
	Diele
	Diele
2	Layer
	Diele
3	Layer
	Diele
	Diele
4	Botto
	Botto
	Botto
	Botto



Filename: QCIOT-ISL3173POCZ Rev A.PcbDoc
Date: 10/22/2024
Layer Name: Drill Guide (Top Layer, Bottom Layer)
Company: RENESAS